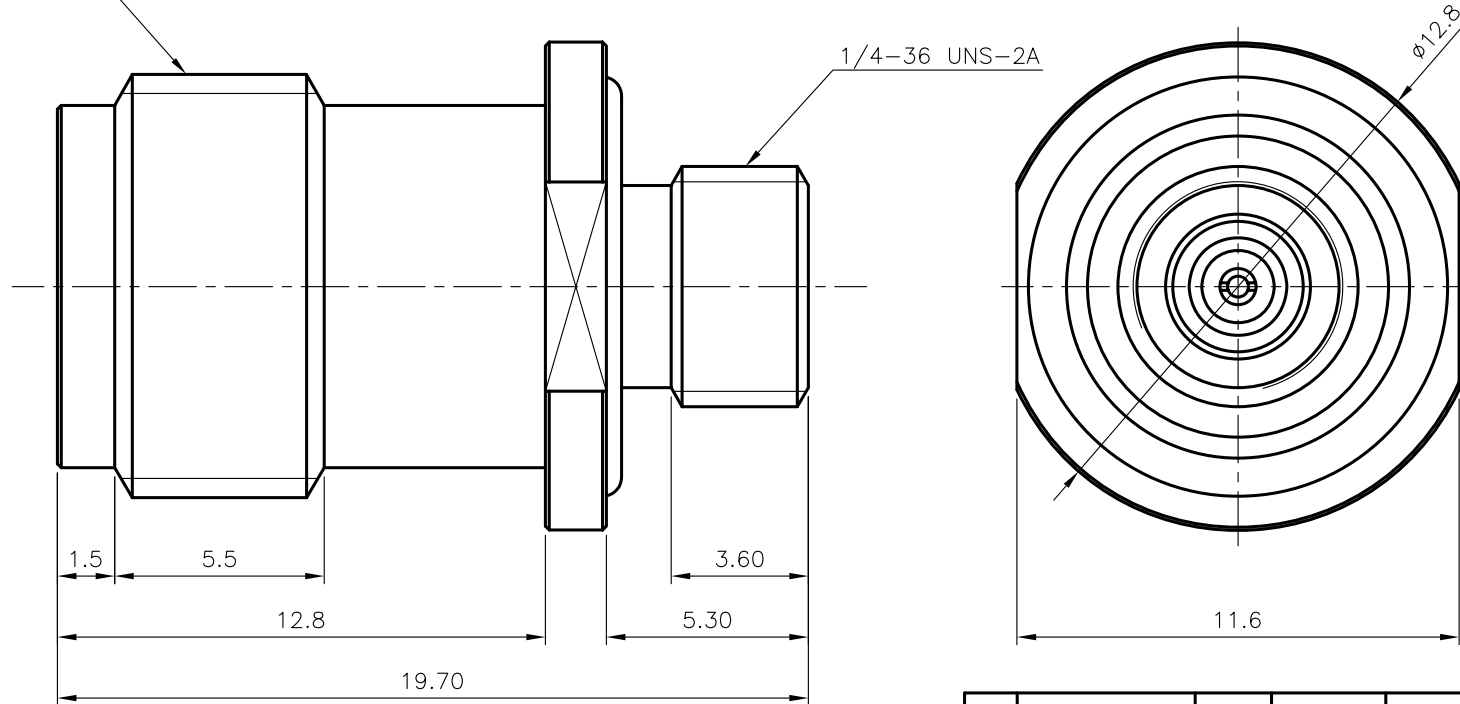


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	I.C.KIM	2013.04.24.
1	절연체 가공성 용이하게 구조 변경_마이크로테크 요청 변경	I.C.KIM		2019.05.08.

7/16-28 UNEF-2A

1/4-36 UNS-2A



► ELECTRICAL SPECIFICATIONS

Frequency	DC~2,000MHz
V.S.W.R	1.5 : 1 (Max)
Insertion Loss	-1.0dB (Min)
Impedance	50Ω (Nominal)

5	GASKET	1	SILICONE		DGK00283-N/1
4	INSULATOR	1	TEFLON		DAI02462-N/1
3	INSULATOR	1	TEFLON		DAI00136-N/1
2	CONTACT	1	BeCu KS D 5102 C1720	Gold Plate (1.27μm)	DAC03237-5/1
1	BODY (A)	1	MBsBD KS D 5101 C3604	Gold Plate (0.5μm)	DAD00292-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2019. 05. 08.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY		
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE MCX50 (J) TNC50 (J) ST ADAPTOR
		DRAWN BY	I.C.KIM	
FINISH		SCALE	5/1	A4 DWG NO. AD00483-7/2 REVISION 1 SHEET 1 of 1
		UNIT	mm	